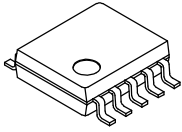


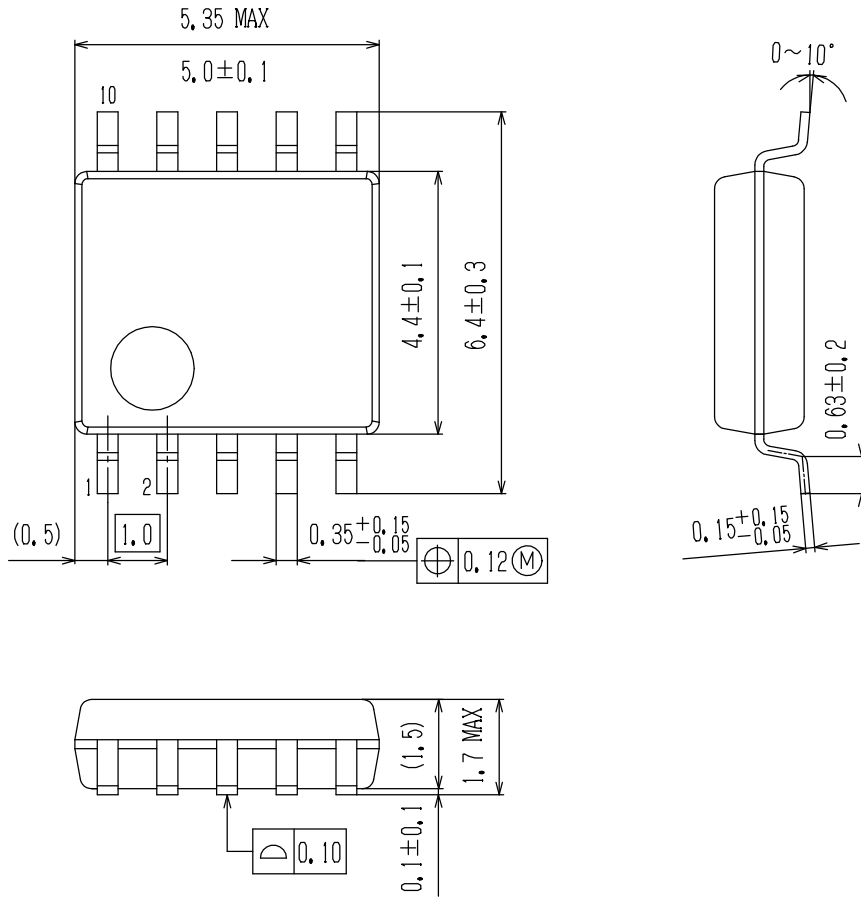
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®



**SOIC10 W / MFP10S (225 mil)**  
**CASE 751BX**  
**ISSUE 0**

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<b>DESCRIPTION:</b>	<b>SOIC10 W / MFP10S (225 MIL)</b>	<b>PAGE 1 OF 2</b>

